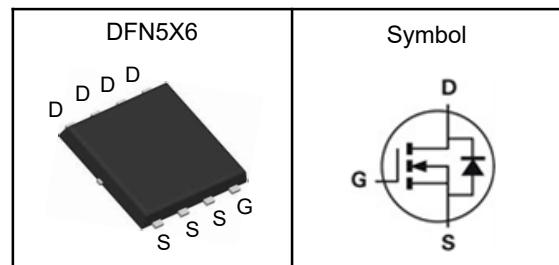


## N-Channel Enhancement Mode MOSFET

### Features

- Advanced SGT technology
- High Speed Power Switching
- Reliable and Rugged
- ROHS Compliant
- 100% Avalanche Tested

### Pin Description



### Applications

- Power Management in Desktop Computer
- DC/DC Converters

$V_{DSS}$	30	V
$R_{DS(ON)-Typ}$	0.6	$m\Omega$
$I_D$	300	A

### Absolute Maximum Ratings ( $T_C=25^\circ C$ , Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
$V_{DSS}$	Drain-Source Voltage	30	V
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ C$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ C$
$I_{DM}^{①}$	Pulse Drain Current Tested	900	A
$I_D$	Continuous Drain Current	300	A
$P_D$	Maximum Power Dissipation	208	W
$E_{AS}$	Avalanche Energy, Single pulse	882	mJ

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	60	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.6	$^\circ C/W$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature  $150^\circ C$ .

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## N-Channel Enhancement Mode MOSFET

**Electrical Characteristics** ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

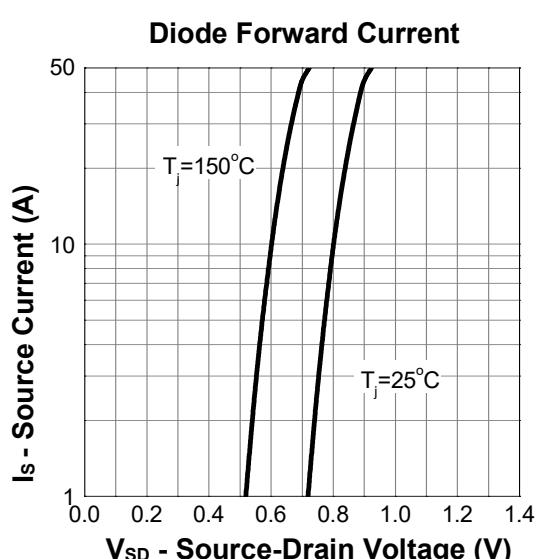
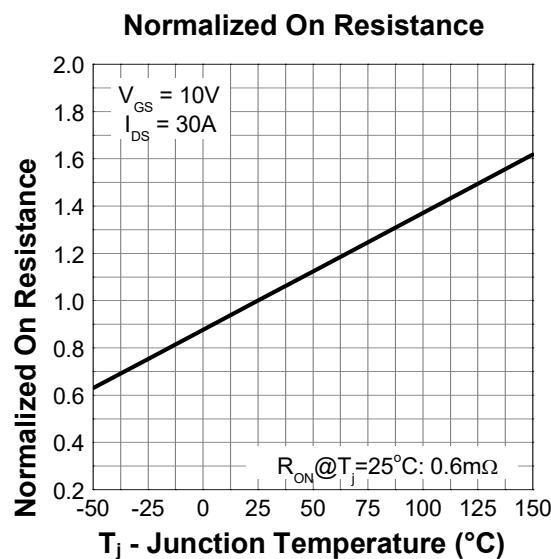
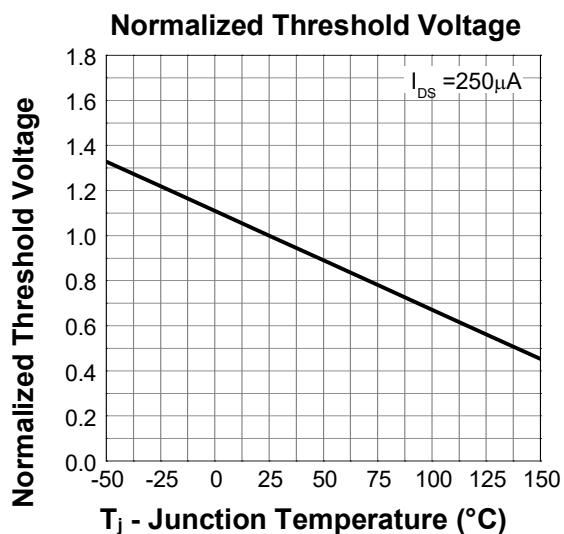
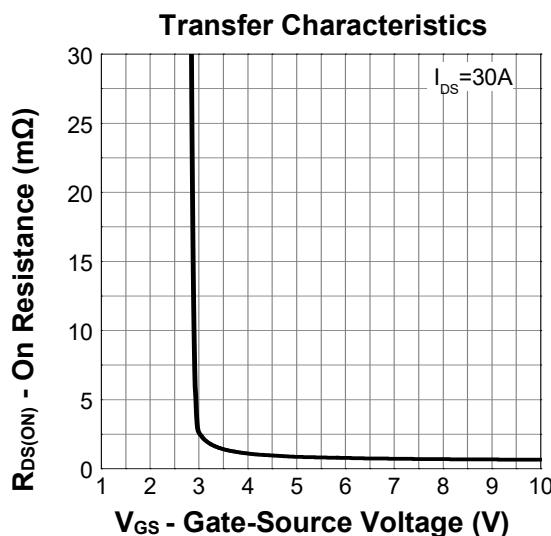
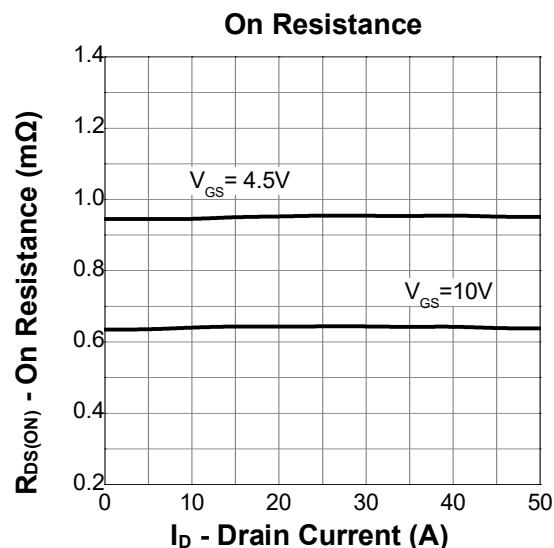
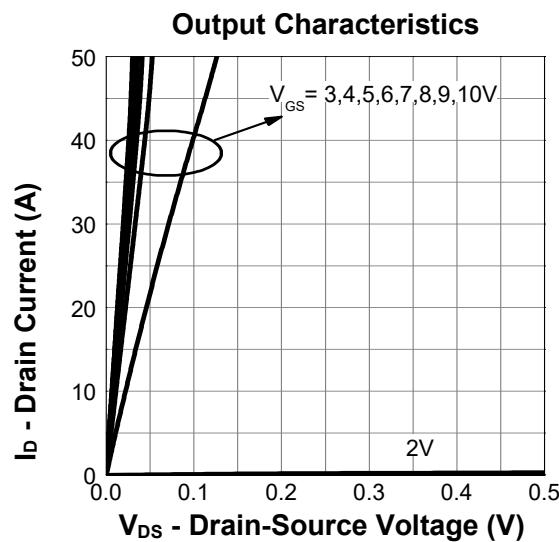
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$\text{V}_{\text{GS}}=0\text{V}$ , $\text{I}_D=250\mu\text{A}$	30	---	---	V
$\text{I}_{\text{DSS}}$	Zero Gate Voltage Drain Current	$\text{V}_{\text{DS}}=24\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$\text{V}_{\text{GS(th)}}$	Gate Threshold Voltage	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}$ , $\text{I}_D=250\mu\text{A}$	1	---	2	V
$\text{I}_{\text{GSS}}$	Gate Leakage Current	$\text{V}_{\text{GS}}=\pm 20\text{V}$ , $\text{V}_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$\text{R}_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=30\text{A}$	---	0.6	0.7	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=4.5\text{V}$ , $\text{I}_D=20\text{A}$	---	0.9	1.1	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$\text{C}_{\text{iss}}$	Input Capacitance	$\text{V}_{\text{DS}}=15\text{V}$ , $\text{V}_{\text{GS}}=0\text{V}$ , Freq.=1MHz	---	5571	---	pF
$\text{C}_{\text{oss}}$	Output Capacitance		---	2050	---	
$\text{C}_{\text{rss}}$	Reverse Transfer Capacitance		---	236	---	
$\text{T}_{\text{d(on)}}$	Turn-on Delay Time	$\text{V}_{\text{DS}}=15\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=30\text{A}$ , $\text{R}_G=3.9\Omega$	---	12	---	nS
$\text{T}_r$	Turn-on Rise Time		---	89	---	
$\text{T}_{\text{d(off)}}$	Turn-off Delay Time		---	110	---	
$\text{T}_f$	Turn-off Fall Time		---	75	---	
$\text{Q}_g$	Total Gate Charge	$\text{V}_{\text{DS}}=15\text{V}$ , $\text{V}_{\text{GS}}=10\text{V}$ , $\text{I}_D=30\text{A}$	---	100	---	nC
$\text{Q}_{\text{gs}}$	Gate-Source Charge		---	17	---	
$\text{Q}_{\text{gd}}$	Gate-Drain Charge		---	16	---	
<b>Source-Drain Characteristics</b>						
$\text{V}_{\text{SD}}$	Diode Forward Voltage	$\text{I}_S=30\text{A}$ , $\text{V}_{\text{GS}}=0\text{V}$	---	---	1.3	V
$\text{t}_{\text{rr}}$	Reverse Recovery Time	$\text{I}_F=30\text{A}$ , $d\text{I}_F/dt=100\text{A}/\mu\text{s}$	---	51	---	nS
$\text{Q}_{\text{rr}}$	Reverse Recovery Charge		---	42	---	nC

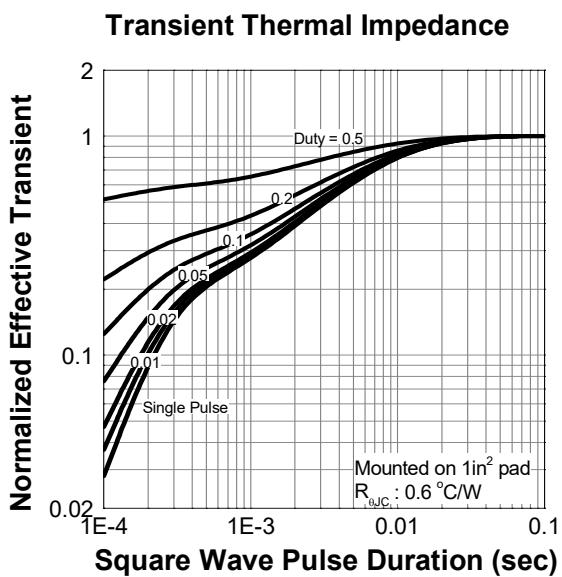
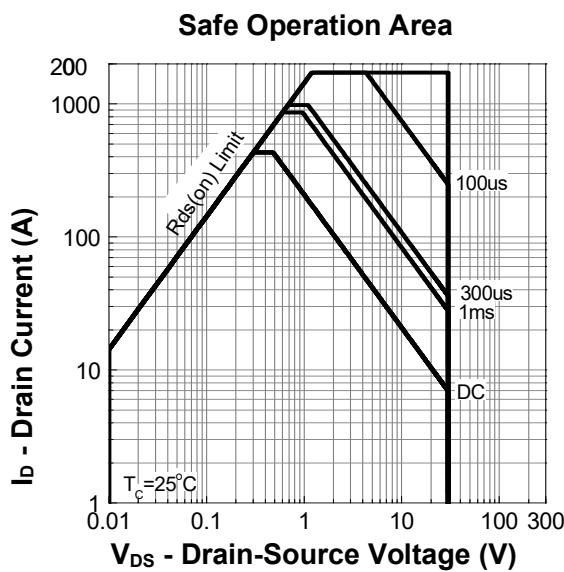
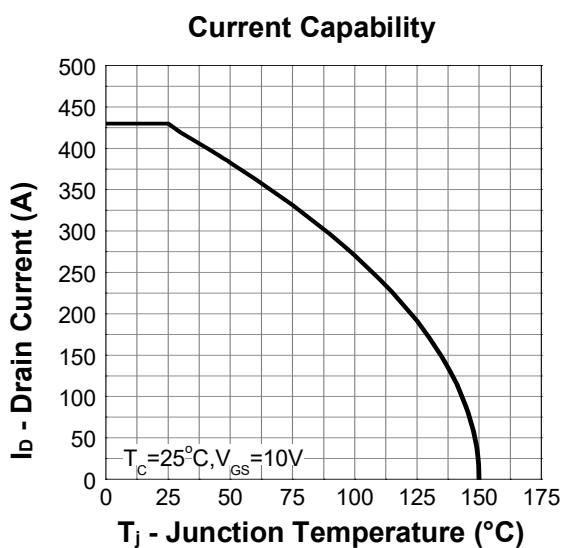
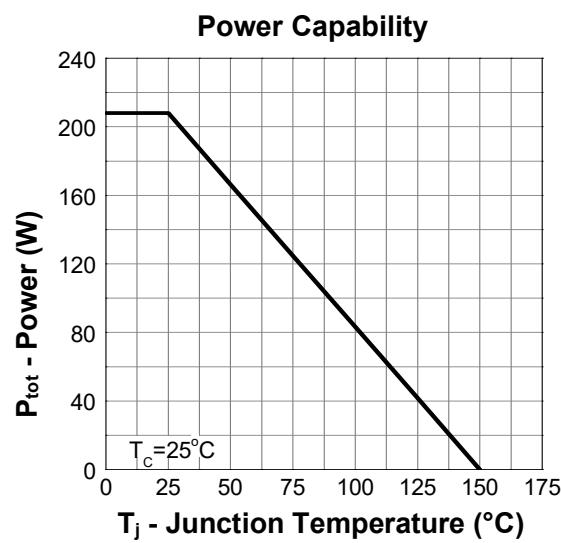
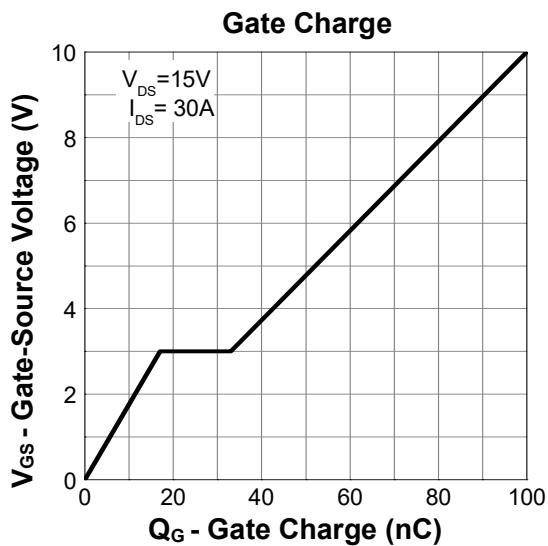
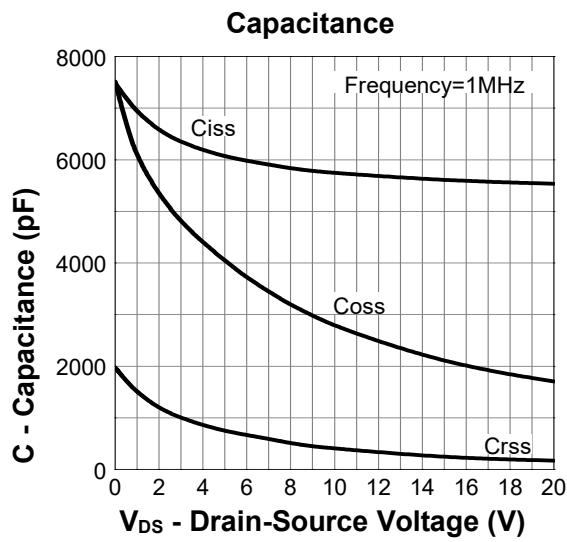
Note ④: Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

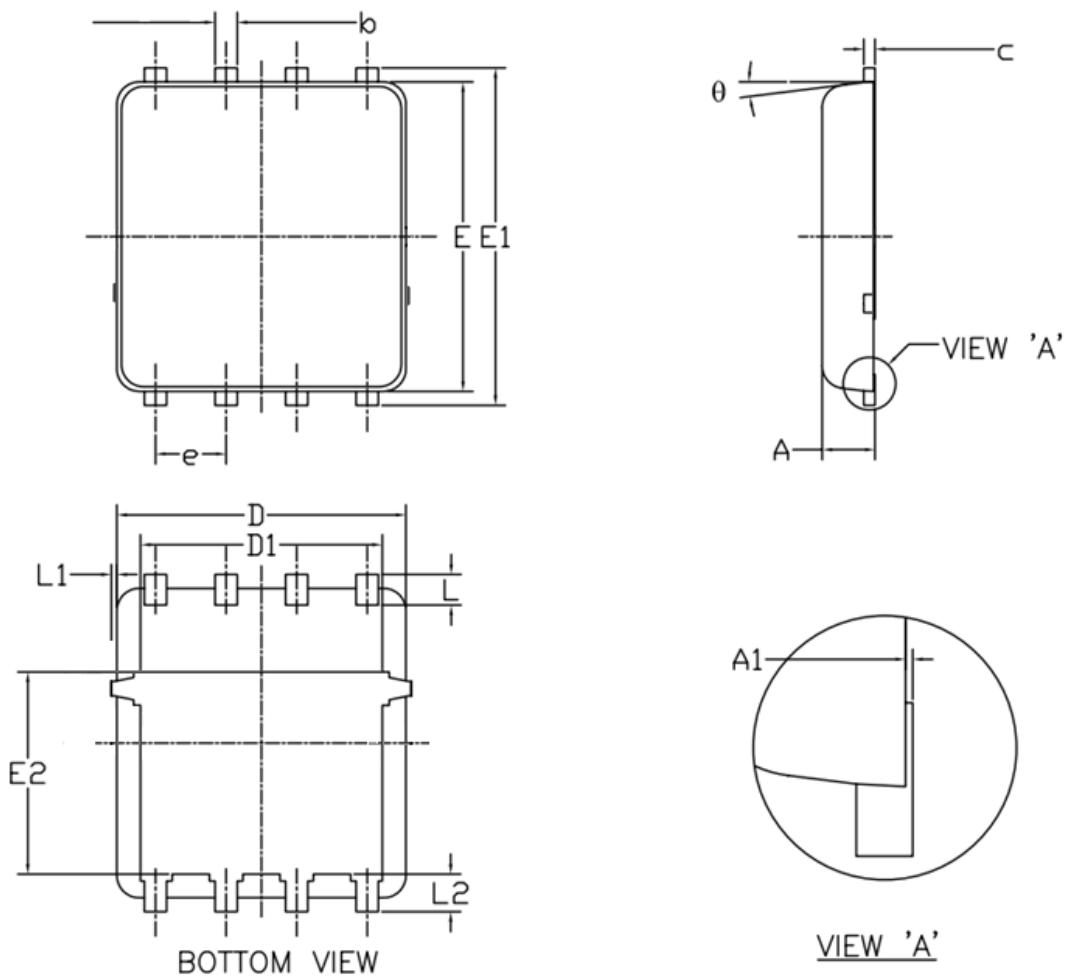
Note ⑤ : Guaranteed by design, not subject to production testing.

## N-Channel Enhancement Mode MOSFET

### Typical Characteristics



**N-Channel Enhancement Mode MOSFET**


**N-Channel Enhancement Mode MOSFET**
**DFN5X6-8L Package Outline Dimensions**


<b>Symbol</b>	<b>Dimensions (unit:mm)</b>			<b>Symbol</b>	<b>Dimensions (unit:mm)</b>		
	<b>Min</b>	<b>Typ</b>	<b>Max</b>		<b>Min</b>	<b>Typ</b>	<b>Max</b>
<b>A</b>	0.90	1.00	1.20	<b>E1</b>	5.90	6.10	6.35
<b>A1</b>	0.00	--	0.05	<b>E2</b>	3.38	3.58	3.92
<b>b</b>	0.30	0.40	0.51	<b>e</b>	1.27 BSC		
<b>c</b>	0.20	0.25	0.33	<b>L</b>	0.51	0.61	0.71
<b>D</b>	4.80	4.90	5.40	<b>L1</b>	--	--	0.15
<b>D1</b>	3.61	4.00	4.25	<b>L2</b>	0.41	0.51	0.61
<b>E</b>	5.65	5.80	6.06	<b><math>\theta</math></b>	0°	--	12°



FSL03N006JT

N-Channel Enhancement Mode MOSFET

## 印字说明

### 印字说明

FSL03N006JT

AABBCC

第一行标记为物料型号代码

第二行为AA为内部识别码，BB为表示年份，例如22即表示2022年，CC表示周期，例如01即表示第一周；  
2201即表示2022年第一周生产。